

XIO 341

X-DIAS Multi I/O Module

Instruction Manual

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Translation of the Original Instructions

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X-DIAS Multi I/O Module

XIO 341

1x LED output 0-20 mA

2x LED output 0-350 mA

1x LED output 0-1 A

3x analog input 0-5 V with +5 V supply

The X-DIAS Multi I/O Module XIO 341 has 4 LED outputs in a range of 0-1 A.

The module also has three analog inputs from 0-5 V with an own +5 V sensor supply.

The external +24 V supply is monitored for undervoltage.



Table of Contents

1 Introduction 4

 1.1 Target Group/Purpose of this Operating Manual 4

 1.2 Important Reference Documentation 4

 1.3 Contents of Delivery 4

2 Basic Safety Directives 5

 2.1 Symbols Used 5

 2.2 Disclaimer 7

 2.3 General Safety Directives 8

3 Standards and Directives 10

 3.1 Directives 10

 3.1.1 EU Conformity Declaration 10

4 Type Plate 11

5 Technical Data 12

 5.1 LED Outputs Specifications 12

 5.2 Analog Input Specifications 13

 5.3 Supply Output Analog Inputs Specifications 13

 5.4 Electrical Requirements 14

 5.5 Voltage monitoring 14

 5.6 Environmental Conditions 15

 5.7 Miscellaneous 15

6 Mechanical Dimensions 16

7 Connector Layout 17

 7.1 Status LEDs 18

 7.2 Applicable Connectors 19

8 Label Field 20

9 Module Coding 21

9.1 Module Coding XIO 341	21
9.2 Coding Hole Positions on Wiring Board (TOP View)	21
10 Wiring	22
10.1 ESD Protection	22
10.2 Wiring Example	23
10.3 Note	24
11 Assembly/Installation	25
11.1 Mounting	25
12 Supported Cycle Times	27
12.1 Cycle Times below 1 ms (in μ s)	27
12.2 Cycle Times equal to or higher than 1 ms (in ms)	27
13 Transport/Storage	28
14 Storage	29
15 Maintenance	30
15.1 Service	30
15.2 Repair	30
16 Disposal	31

1 Introduction

1.1 Target Group/Purpose of this Operating Manual

This operating manual contains all information required for the operation of the product.

This operating manual is intended for:

- Project planners
- Technicians
- Commissioning engineers
- Machine operators
- Maintenance/test technicians

General knowledge of automation technology is required.

Further help and training information, as well as the appropriate accessories can be found on our website www.sigmatek-automation.com.

Our support team is happily available to answer your questions.
Please see our website for our hotline number and business hours.

1.2 Important Reference Documentation

- X-DIAS Designguide

This and additional documents can be downloaded from our website or obtained through support.

1.3 Contents of Delivery

1x XIO 341

2 Basic Safety Directives

2.1 Symbols Used

The following symbols are used in the operator documentation for warning and danger messages, as well as informational notes.



DANGER

Danger indicates that death or serious injury **will occur**, if the specified measures are not taken.

→ To avoid death or serious injuries, observe all guidelines.

Danger indique une situation dangereuse qui, faute de prendre les mesures adéquates, **entraînera** des blessures graves, voire mortelles.

→ Respectez toutes les consignes pour éviter des blessures graves, voire mortelles.



WARNING

Warning indicates that death or serious injury **can** occur, if the specified measures are not taken.

→ To avoid death or serious injuries, observe all guidelines.

Avertissement d'une situation dangereuse qui, faute de prendre les mesures adéquates, **entraînera** des blessures graves, voire mortelles.

→ Respectez toutes les consignes pour éviter des blessures graves, voire mortelles.

CAUTION

Caution indicates that moderate to slight injury **can** occur, if the specified measures are not taken.

→ To avoid moderate to slight injuries, observe all guidelines.

Attention indique une situation dangereuse qui, faute de prendre les mesures adéquates, **peut** entraîner des blessures assez graves ou légères.

→ Respectez toutes les consignes pour éviter des blessures graves, voire mortelles.

CAUTION

Danger for ESD-sensitive components.

Les signes de danger pour les composants sensibles aux décharges électrostatiques.

INFORMATION**INFORMATION**

→ Provides important information on the product, handling or relevant sections of the documentation, which require particular attention.

2.2 Disclaimer

INFORMATION



The contents of this operating manual were prepared with the greatest care. However, deviations cannot be ruled out. This operating manual is regularly checked and required corrections are included in the subsequent versions. The machine manufacturer is responsible for the proper assembly, as well as device configuration. The machine operator is responsible for safe handling, as well as proper operation.

The current operating manual can be found on our website. If necessary, contact our support.

Subject to technical changes, which improve the performance of the devices. The following operating manual is purely a product description. It does not guarantee properties under the warranty.

Please thoroughly read the corresponding documents and this operating manual before handling a product.

SIGMATEK GmbH & Co KG is not liable for damages caused through, non-compliance with these instructions or applicable regulations.

2.3 General Safety Directives

The Safety Directives in the other sections of this operating manual must be observed. These instructions are visually emphasized by symbols.



INFORMATION

According to EU Directives, the operating manual is a component of a product.

This operating manual must therefore be accessible in the vicinity of the machine since it contains important instructions.

This operating manual should be included in the sale, rental or transfer of the product, or its online availability indicated.

Regarding the requirements for Safety and health connected to the use of machines, the manufacturer must perform a risk assessment in accordance with machine directives 2006/42/EG before introducing a machine to the market.

Operate the unit with devices and accessories approved by SIGMATEK only.

CAUTION

Handle the device with care and do not drop or let fall.
Prevent foreign bodies and fluids from entering the device.
The device must not be opened!

Manipulez l'appareil avec précaution et ne le laissez pas tomber.
Empêchez les corps étrangers et les liquides de pénétrer dans l'appareil.
L'appareil ne doit pas être ouvert!

If the device does not function as intended or has damage that could pose a danger, it must be replaced!

En cas de fonctionnement non conforme ou de dommages pouvant entraîner des risques, l'appareil doit être remplacé !

The module complies with EN 61131-2.
In combination with a facility, the system integrator must comply with EN 60204-1 standards.
For your own safety and that of others, compliance with the environmental conditions is essential.

Le module est conforme à la norme EN 61131-2.
En combinaison avec une équipement, l'intégrateur de système doit respecter la norme EN 60204-1.
Pour votre propre sécurité et celle des autres, le respect des conditions environnementales est essentiel.

3 Standards and Directives

3.1 Directives

The product was constructed in compliance with the following European Union directives and tested for conformity.

3.1.1 EU Conformity Declaration



EU Declaration of Conformity

The product XIO 341 conforms to the following European directives:

- **2014/35/EU** Low-voltage Directive
- **2014/30/EU** Electromagnetic Compatibility (EMC Directive)
- **2011/65/EU** "Restricted use of certain hazardous substances in electrical and electronic equipment" (RoHS Directive)

The EU Conformity Declarations are provided on the SIGMATEK website. They can be found in the download area of the respective product.

4 Type Plate

Approbations		Standards
	Short Name Specifications	 SIGMA TEK Sigmatekstraße 1 A-5112 Lamprechtshausen www.sigmatek-automation.com
Serial No. XXXXXXXX	FW: XXX LD: XX.X HW: X.XX	
Article Number		Product Name

Exemplary nameplate (symbol image)

Approbations		Standards
	XAI 022 2x load cells 24bit	 SIGMA TEK Sigmatekstraße 1 A-5112 Lamprechtshausen www.sigmatek-automation.com
S/N 04522873	FW: 3.00 LD: L1.4 HW: 1.00	
21-009-022		X-DIAS Analog Input

HW: Hardware version
SW: Software version
FW: Firmware version
LD: Logic Device version

5 Technical Data

5.1 LED Outputs Specifications

Number	4
LED output 1	0-20 mA at max. +10 V LED forward bias
Resolution LED output 1	8-bit
LED output 2	0-350 mA at max. +12 V LED forward bias up to 50 °C ambient temperature
	0-245 mA at max. +12 V LED forward bias up to 55 °C ambient temperature
Resolution LED output 2	8-bit
LED output 3	0-350 mA at max. +12 V LED forward bias up to 50 °C ambient temperature
	0-245 mA at max. +12 V LED forward bias up to 55 °C ambient temperature
Resolution LED output 3	8-bit
LED output 4	0-1000 mA at max. +18 V LED forward bias up to 50 °C ambient temperature
	0-700 mA at max. +18 V LED forward bias up to 55 °C ambient temperature
Resolution LED output 4	8-bit

5.2 Analog Input Specifications

Number of channels	3	
Measurement range	0 ... +5 V	0 ... 100 %
Measurement value	0 ... 5,000	0 ... 10,000
	with an open input, the firmware returns the positive maximum value and a status bit to indicate a cable break (HW class shows the value - 2147483632)	
Input type	single ended (absolute)	single ended (relative)
Resolution	12-bit (ca. 1.3 mV/LSB)	
Conversion time for all channels	1 ms	
Input resistance	> 1 MΩ	
Cable break monitor	yes	
Input filter hardware	typically 1 kHz, 3 rd order low pass	
Input filter software	configurable, 1 st order low-pass	
Measurement precision	±0.50 % of the maximum measured value	

5.3 Supply Output Analog Inputs Specifications

Number of channels	1
Output voltage	+5 V
Permissible output current	maximum 60 mA
Permissible capacitive load	maximum 100 nF
Short-circuit proof	ja
Accuracy	±0,5 %

5.4 Electrical Requirements

Voltage supply from S-DIAS bus	+24 V DC $\pm 20\%$ (SELV/PELV) UL: NEC Class 2	
Protection class	III	
Current consumption on the S-DIAS bus (+24 V supply)	typically 26.5 mA	maximum 33 mA
Supply for I/Os	+24 V $\pm 20\%$	
Current consumption I/O supply	load-dependent (max. 1.45 A at full load of the LED outputs)	

INFORMATION



For USA and Canada:

The supply must be limited to:

- a) max. 5 A at voltages from 0-20 V DC, or
- b) 100 W at voltages from 20-60 V DC

The limiting component (e.g. transformer, power supply or fuse) must be certified by an NRTL (Nationally Recognized Testing Laboratory).

If this X-DIAS module is used on an S-DIAS supply module with several S-DIAS and X-DIAS modules, the total currents of the S-DIAS and X-DIAS modules used must be determined and checked. The total current of the +24 V supply must not exceed 1.6 A! The specification for the current can be found in the module-specific documentation under "Electrical Requirements".

5.5 Voltage monitoring

Supply voltage +24 V	supply voltage > 19.2 V (DC OK - LED lights up green)
----------------------	---

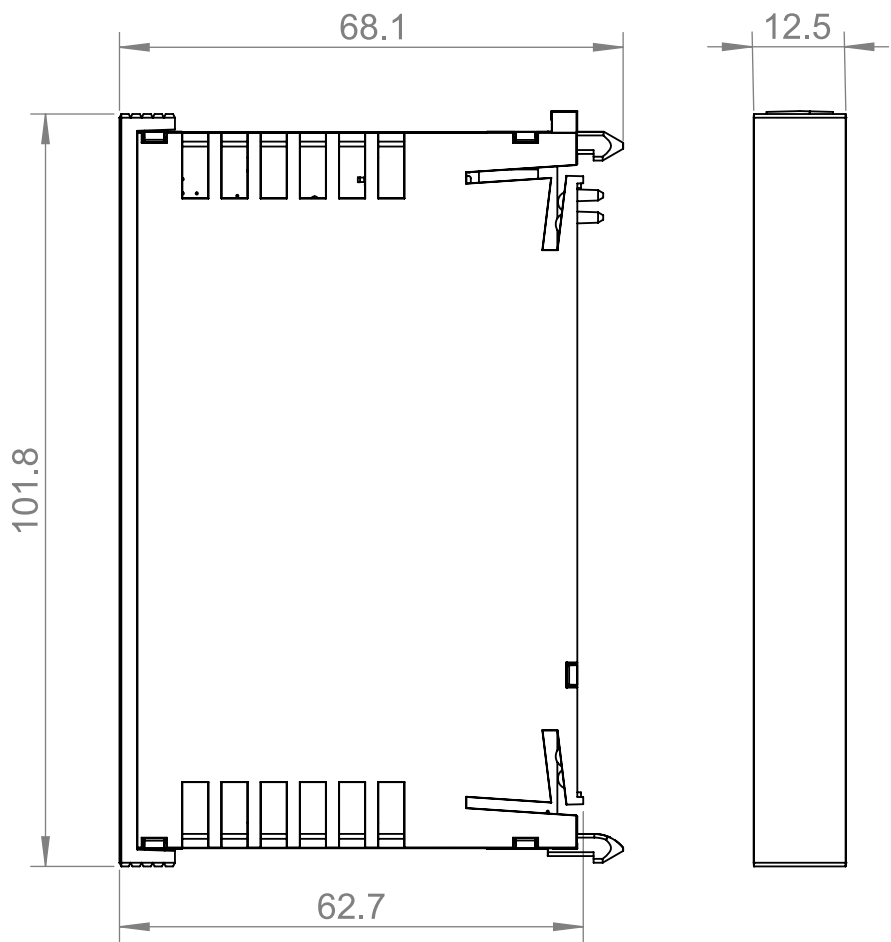
5.6 Environmental Conditions

Storage temperature	-40 ... +85 °C	
Environmental temperature	-25 ... +55 °C	
Humidity	0-95 %, non-condensing	
Installation altitude above sea level	0-2000 m without derating > 2000 m up to a maximum of 5000 m with derating of the maximum environmental temperature by 0.5 °C per 100 m	
Operating conditions	pollution degree 2	
Noise emission	≤ 70 dB	
EMC resistance	EN 61000-6-2 (industrial area)	
EMC noise generation	EN 61000-6-4 (industrial area)	
Vibration resistance	EN 60068-2-6	3.5 mm from 5-8.4 Hz 1 g from 8.4-150 Hz
Shock resistance	EN 60068-2-27	15 g (147.15 m/s ²)
Protection type	EN 60529/NEMA 250	IP20/Type1

5.7 Miscellaneous

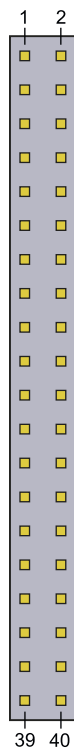
Article number	21-013-341	
Printed circuit board coating	no	
Standard	designed according to UL	
Approvals	CE	

6 Mechanical Dimensions

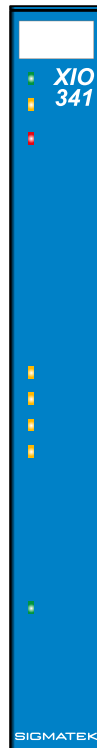


Measurements	12.5 x 101.8 x 62.7 mm (W x H x D)
Weight	0.2 kg

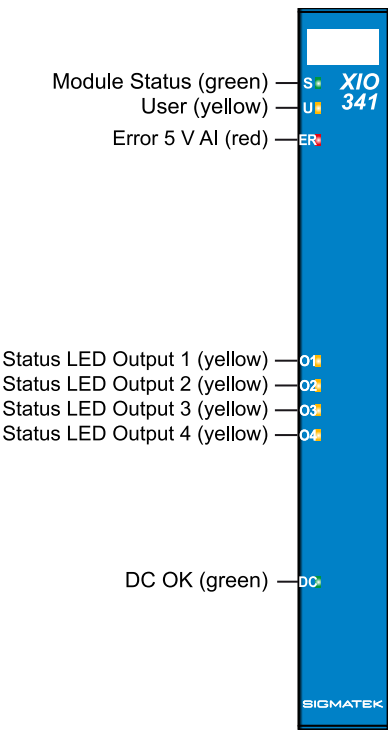
7 Connector Layout



Pin		Signal		Description
1	2	+24 V bus	+24 V bus	S-DIAS bus The +24 V voltage supply is provided by the S-DIAS CPU or the S-DIAS interface module.
3	4	GND	GND	
5	6	RxD- OUT	RxD- IN	
7	8	RxD+ OUT	RxD+ IN	
9	10	GND	GND	
11	12	TxD- IN	TxD- OUT	
13	14	TxD+ IN	TxD+ OUT	
15	16	GND	GND	
17	18	AI1	AI2	I/O signals
19	20	AI3	n.c.	
21	22	+5 V_AI	GND_AI	
23	24	n.c.	n.c.	
25	26	LED1+	LED1-	
27	28	LED2+	LED2-	
29	30	LED3+	LED3-	
31	32	LED4+	LED4-	
33	34	+24 V I/O	+24 V I/O	
35	36	+24 V I/O	+24 V I/O	
37	38	GND	GND	
39	40	GND	GND	



7.1 Status LEDs

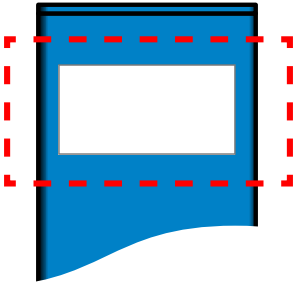


Module status	green	ON	module active
		OFF	no supply available
		BLINKING (5 Hz)	no communication
User	yellow	ON	adjustable by application (e.g. the module LED can be set to blinking through the visualization so that the module is easily found in the control cabinet)
		OFF	
		BLINKING (2 Hz)	
		BLINKING (4 Hz)	
Error 5V AI	red	ON	overload 5 V AI supply
		OFF	no errors
Status LED output x	yellow	ON	LED output x active
		OFF	LED output x inactive
DC OK	green	ON	external voltage supply in order
		OFF	no external voltage supply available

7.2 Applicable Connectors

Connector wiring board: Samtec SSQ-120-01-L-D

8 Label Field



The labeling field is printed directly on the module.

9 Module Coding

X-DIAS modules have module coding by means of coding pins on the module housing. In combination with coding holes on the wiring board, a mismatching protection can be realized.

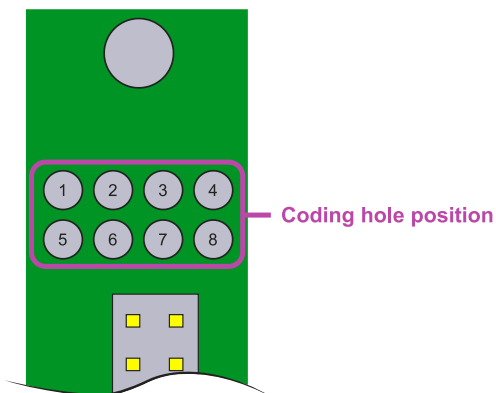
9.1 Module Coding XIO 341

Position 1	Position 2	Position 3	Position 4	Position 5	Position 6	Position 7	Position 8
X	X	X	O	O	X	O	O

X ... Coding pin present on the module -> there must be a coding hole on the wiring board

O ... No coding pin present on the module -> there must be no coding hole on the wiring board

9.2 Coding Hole Positions on Wiring Board (TOP View)



10 Wiring

10.1 ESD Protection

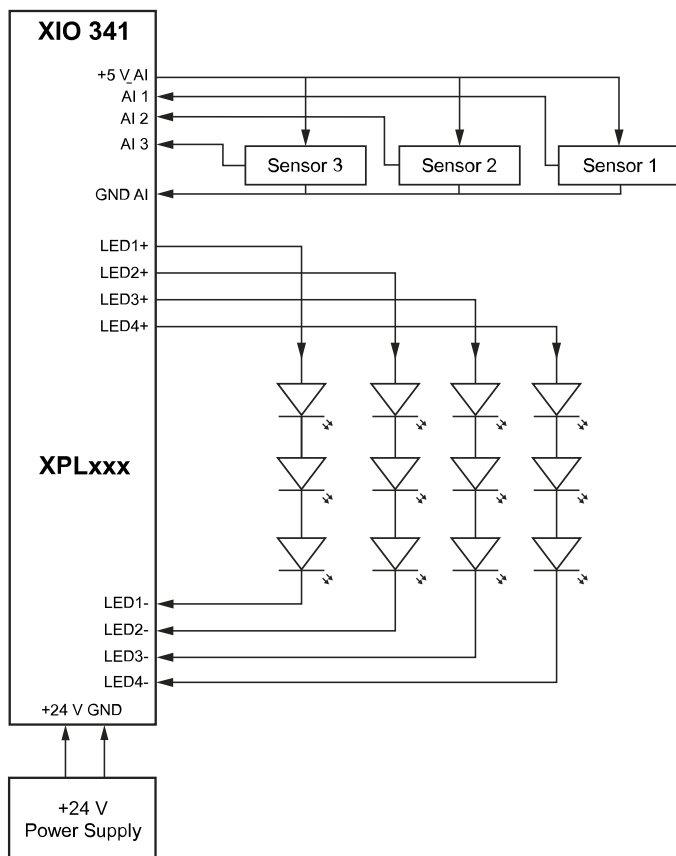
CAUTION



The operator must ensure that no ESD interference affects the product.

L'opérateur doit s'assurer qu'aucune interférence due à des décharges électrostatiques n'affecte le produit.

10.2 Wiring Example



10.3 Note

The signals recorded by the analog modules are very small, as compared to the digital signals. To ensure error-free operation, a careful wiring method must be followed:

- The functional grounding of the X-DIAS modules is carried out via their GND connection on the wiring board. The wiring board must be connected to the grounded switch cabinet mounting plate with low resistance via the mounting screws.
- Signal cables > 3 m for the LEDs must be shielded.
- The lines connected to the source of the analog signals must be as short as possible and parallel wiring to digital signal lines must be avoided.
- The analog signal lines must be shielded.
- The shielding of the analog signals must be connected as close as possible to the connector plug of the wiring board with the functional ground of the wiring board or the rear panel of the control cabinet.
- Avoid parallel connections between input lines and load-bearing circuits.
- Protective circuits for all relays (RC networks or free-wheeling diodes).

INFORMATION



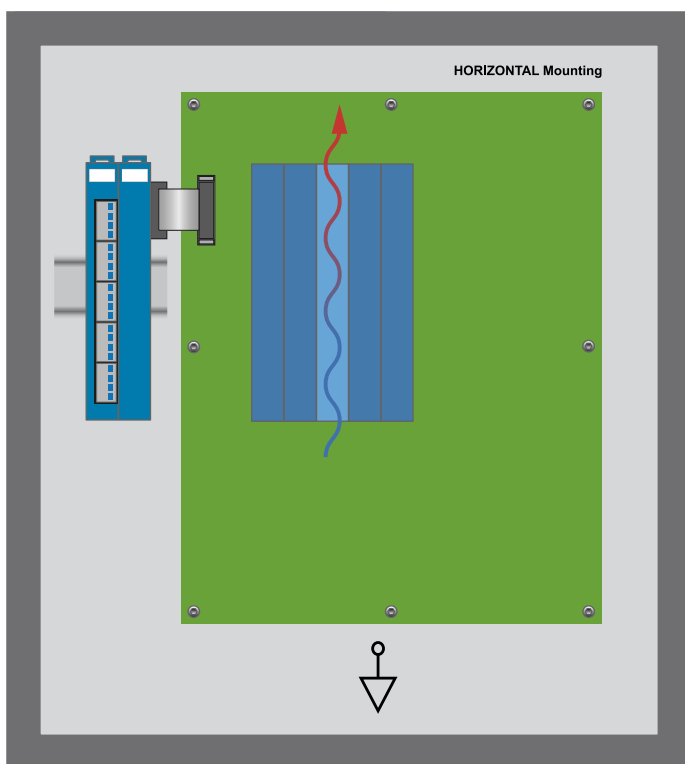
The X-DIAS module CANNOT be connected/disconnected while voltage is applied!

Le module X-DIAS NE PEUT PAS être connecté/déconnecté lorsque la tension est appliquée!

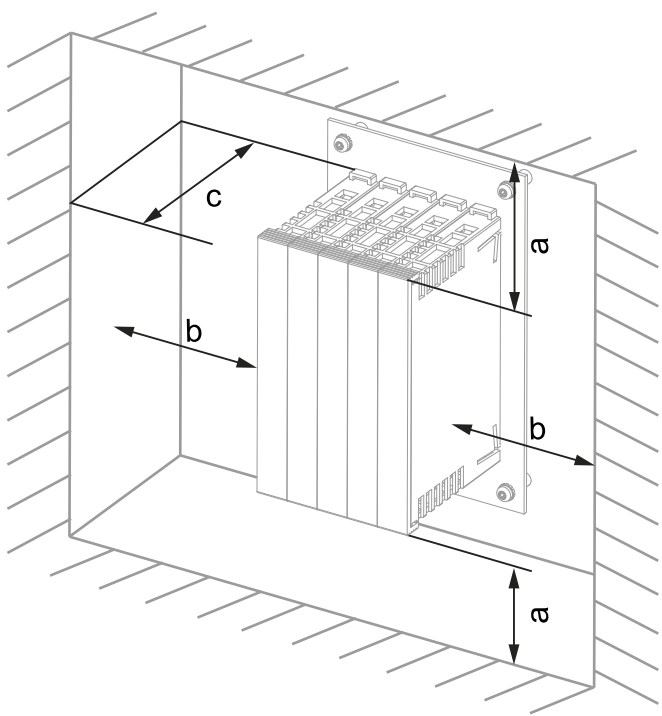
11 Assembly/Installation

11.1 Mounting

The S-DIAS modules are designed for installation into the control cabinet. To mount the modules, a DIN-rail is required. The DIN rail must establish a conductive connection with the back wall of the control cabinet. The individual S-DIAS modules are mounted on the DIN rail as a block and secured with latches. The functional ground connection from the module to the DIN rail is made via the grounding lug on the back of the S-DIAS modules. The modules must be mounted horizontally (module label up) with sufficient clearance between the ventilation slots of the S-DIAS module blocks and nearby components and/or the control cabinet wall. This is necessary for optimal cooling and air circulation to ensure proper function up to the maximum operating temperature.



Recommended minimum distances between the S-DIAS modules and the surrounding components or control cabinet wall:



a	b	c
30 mm (1.18")	30 mm (1.18")	90 mm (3.54")

a, b, c ... distances in mm (inches)

12 Supported Cycle Times

12.1 Cycle Times below 1 ms (in μs)

50	100	125	200	250	500
x	x	x	x	x	x

x = supported

12.2 Cycle Times equal to or higher than 1 ms (in ms)

1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
x	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x

x = supported

17	18	19	20	21	22	23	24	25	26	27	28	29	30	31	32
x	x	x	x	x	x	x	x	x	x	x	x	x	x	x	x

x = supported

13 Transport/Storage



INFORMATION

This device contains sensitive electronics. During transport and storage, high mechanical stress must therefore be avoided.

For storage and transport, the same values for humidity and vibration as for operation must be maintained!

Temperature and humidity fluctuations may occur during transport. Ensure that no moisture condenses in or on the device, by allowing the device to acclimate to the room temperature while turned off.

When sent, the device should be transported in the original packaging if possible. Otherwise, packaging should be selected that sufficiently protects the product from external mechanical influences. Such as cardboard filled with air cushioning.

14 Storage

INFORMATION



When not in use, store the operating panel according to the storage conditions. See chapter 13 Transport/Storage.

During storage, ensure that all protective covers (if available) are placed correctly, so that no contamination, foreign bodies or fluids enter the device.

15 Maintenance

INFORMATION



During maintenance as well as servicing, observe the safety instructions from chapter 2 Basic Safety Directives.

Lors de l'entretien et de la maintenance, respectez les consignes de sécurité du chapitre 2 Basic Safety Directives.

15.1 Service

This product was constructed for low-maintenance operation.

15.2 Repair

INFORMATION



In the event of a defect/repair, send the device with a detailed error description to the address listed at the beginning of this document. For transport conditions, see chapter 13 Transport/Storage.

16 Disposal



INFORMATION

Should you need to dispose of the device, the national regulations for disposal must be followed.

The device appliance must not be disposed of as household waste.



Change History

Change date	Affected page(s)	Chapter	Note
30.09.2024		Document	Revision
17.12.2024		Document	Layout changes
03.02.2025		Document	Layout changes
06.02.2025	15	5.6 Environmental Conditions	Environmental and storage temperature changed